



#### **45V PNP SMALL SIGNAL TRANSISTOR IN DFN0806**

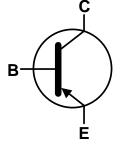
### **Features**

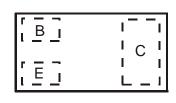
- BV<sub>CEO</sub> > -45V
- I<sub>C</sub> = -100mA High Collector Current
- P<sub>D</sub> = 435mW Power Dissipation
- 0.48mm<sup>2</sup> Package Footprint, 16 times smaller than SOT23
- 0.4mm Height Package Minimizing Off-Board Profile
- Complementary NPN Type BC847BFA
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

## **Mechanical Data**

- Case: X2-DFN0806-3
- Case Material: Molded Plastic, "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu, Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.0008 grams (Approximate)







Device Symbol

Top View Device Schematic

### Ordering Information (Note 4)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
BC857BFA-7B	3W	7	8mm	10,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**

X2-DFN0806-3

Top View Bar Denotes Base and Emitter Side

3W = Product Type Marking Code

### Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	$V_{CBO}$	-50	V
Collector-Emitter Voltage	V <sub>CEO</sub>	-45	V
Emitter-Base Voltage	$V_{EBO}$	-6.0	V
Continuous Collector Current	Ic	-100	mA
Peak Pulse Collector Current	I <sub>CM</sub>	-200	mA



### Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	$P_{D}$	435	mW
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>0JA</sub>	287	°C/W
Thermal Resistance, Junction to Lead (Note 6)	$R_{ hetaJL}$	150	°C/W
Operating and Storage and Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

### ESD Ratings (Note 7)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	200	V	В

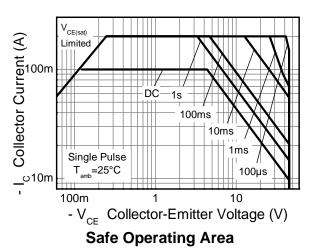
Notes:

5. For the device mounted on minimum recommended pad layout 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in steady state condition. The entire exposed collector pad is attached to the heatsink.

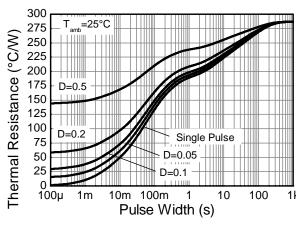
0.45

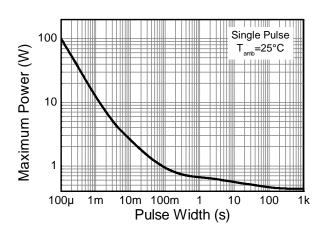
- 6. Thermal resistance from junction to solder-point (on the exposed collector pad).
- 7. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

## **Thermal Characteristics and Derating Information**



0.40 Max Power Dissipation (W) 0.35 0.30 0.25 0.20 0.15 0.10 0.05 0.00 60 80 100 20 120 140 160 Temperature (°C) **Derating Curve** 





**Transient Thermal Impedance** 

**Pulse Power Dissipation** 

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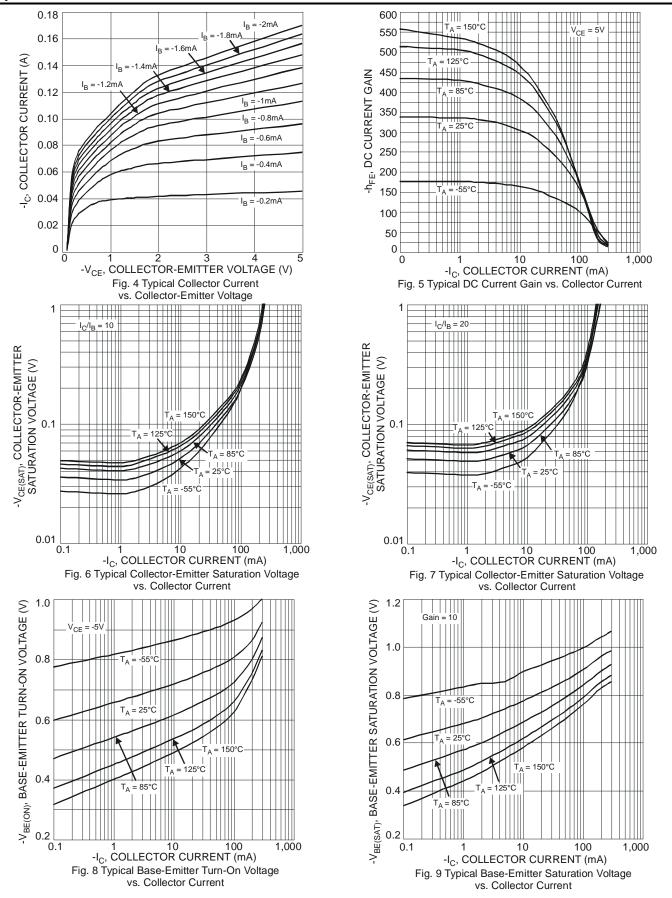
## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typical	Max	Unit	Test Condition	
OFF CHARACTERISTICS							
Collector-Base Breakdown Voltage	$BV_{CBO}$	-50	-100	_	<b>V</b>	$I_C = -50\mu A, I_B = 0$	
Collector-Emitter Breakdown Voltage	BV <sub>CES</sub>	-50	-90	_		$I_C = -50\mu A, I_B = 0$	
Collector-Emitter Breakdown Voltage (Note 8)	$BV_{CEO}$	-45	-65		<b>V</b>	$I_{C} = -1 \text{mA}, I_{B} = 0$	
Collector-Base Breakdown Voltage	$BV_{EBO}$	-6.0	-8.5	_	V	$I_E = -50\mu A, I_C = 0$	
Collector-Base Cut-Off Current	I <sub>CBO</sub>	_		-15	nA	V <sub>CB</sub> = -40V	
Collector-Emitter Cut-Off Current	ICES	_		-15	nA	V <sub>CE</sub> = -40V	
ON CHARACTERISTICS (Note 8)							
DC Current Gain	b	200	340	_		$I_C = -10\mu A, V_{CE} = -5.0V$	
DC Current Gain	h <sub>FE</sub>		330	470		$I_C = -2.0 \text{mA}, V_{CE} = -5.0 \text{V}$	
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	_	-70	-175	mV	$I_C = -10 \text{mA}, I_B = -0.5 \text{mA}$	
Collector-Entitle Saturation Voltage			-300	-500		$I_C = -100 \text{mA}, I_B = -5.0 \text{mA}$	
Base-Emitter Saturation Voltage	V25( )			-760	-1,000	1 m\/	$I_C = -10mA$ , $I_B = -0.5mA$
Dase Emilier Galdration Voltage	V <sub>BE(sat)</sub>		-885	-1,100	111.0	$I_C = -100 \text{mA}, I_B = -5.0 \text{mA}$	
Base-Emitter Voltage	Vac	(on) -600	-670	-780	mV	$I_C = -2.0 \text{mA}, V_{CE} = -5 \text{V}$	
	V <sub>BE(on)</sub>		-715	-850		$I_C = -10 \text{mA}, V_{CE} = -5 \text{V}$	
SMALL SIGNAL CHARACTERISTICS							
Output Capacitance	$C_{obo}$	_	2.0	_	рF	$V_{CB} = -10.0V$ , $f = 1.0MHz$ , $I_E = 0$	
Current Gain-Bandwidth Product	f⊤	100	340		MHz	$V_{CE} = -5V, I_{C} = -10mA,$	
Carron Cam Banaman Froduct	'1	.50	3 10		141112	f = 100MHz	

Notes: 8. Measured under pulsed conditions. Pulse width  $\leq 300 \mu s$ . Duty cycle  $\leq 2\%$ .



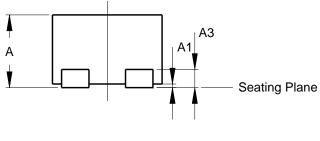
## Typical Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

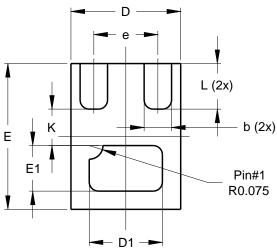




# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

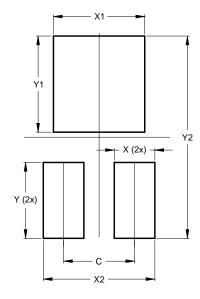




X2-DFN0806-3				
Dim	Min	Max	Тур	
Α	0.375	0.40	0.39	
A1	0	0.05	0.02	
A3	-	-	0.10	
b	0.10	0.20	0.15	
D	0.55	0.65	0.60	
D1	0.35	0.45	0.40	
Е	0.75	0.85	0.80	
E1	0.20	0.30	0.25	
е	-	-	0.35	
K	-	-	0.20	
Ĺ	0.20	0.30	0.25	
All Dimensions in mm				

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)		
С	0.350		
Х	0.200		
X1	0.450		
X2	0.550		
Υ	0.375		
Y1	0.475		
Y2	1.000		



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